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### Understanding [Embedded - CPLDs \(Complex Programmable Logic Devices\)](#)

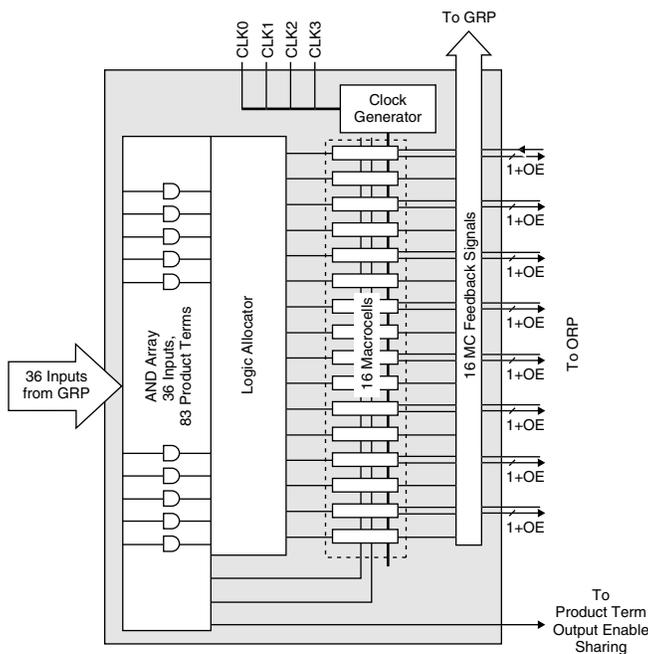
Embedded - CPLDs, or Complex Programmable Logic Devices, are highly versatile digital logic devices used in electronic systems. These programmable components are designed to perform complex logical operations and can be customized for specific applications. Unlike fixed-function ICs, CPLDs offer the flexibility to reprogram their configuration, making them an ideal choice for various embedded systems. They consist of a set of logic gates and programmable interconnects, allowing designers to implement complex logic circuits without needing custom hardware.

### Applications of Embedded - CPLDs

#### Details

Product Status	Obsolete
Programmable Type	In System Programmable
Delay Time tpd(1) Max	7.5 ns
Voltage Supply - Internal	1.65V ~ 1.95V
Number of Logic Elements/Blocks	8
Number of Macrocells	128
Number of Gates	-
Number of I/O	64
Operating Temperature	-40°C ~ 105°C (Tj)
Mounting Type	Surface Mount
Package / Case	100-LQFP
Supplier Device Package	100-TQFP (14x14)
Purchase URL	<a href="https://www.e-xfl.com/product-detail/lattice-semiconductor/lc4128c-75t100i">https://www.e-xfl.com/product-detail/lattice-semiconductor/lc4128c-75t100i</a>

Figure 2. Generic Logic Block



**AND Array**

The programmable AND Array consists of 36 inputs and 83 output product terms. The 36 inputs from the GRP are used to form 72 lines in the AND Array (true and complement of the inputs). Each line in the array can be connected to any of the 83 output product terms via a wired-AND. Each of the 80 logic product terms feed the logic allocator with the remaining three control product terms feeding the Shared PT Clock, Shared PT Initialization and Shared PT OE. The Shared PT Clock and Shared PT Initialization signals can optionally be inverted before being fed to the macrocells.

Every set of five product terms from the 80 logic product terms forms a product term cluster starting with PT0. There is one product term cluster for every macrocell in the GLB. Figure 3 is a graphical representation of the AND Array.

**Table 5. Product Term Expansion Capability**

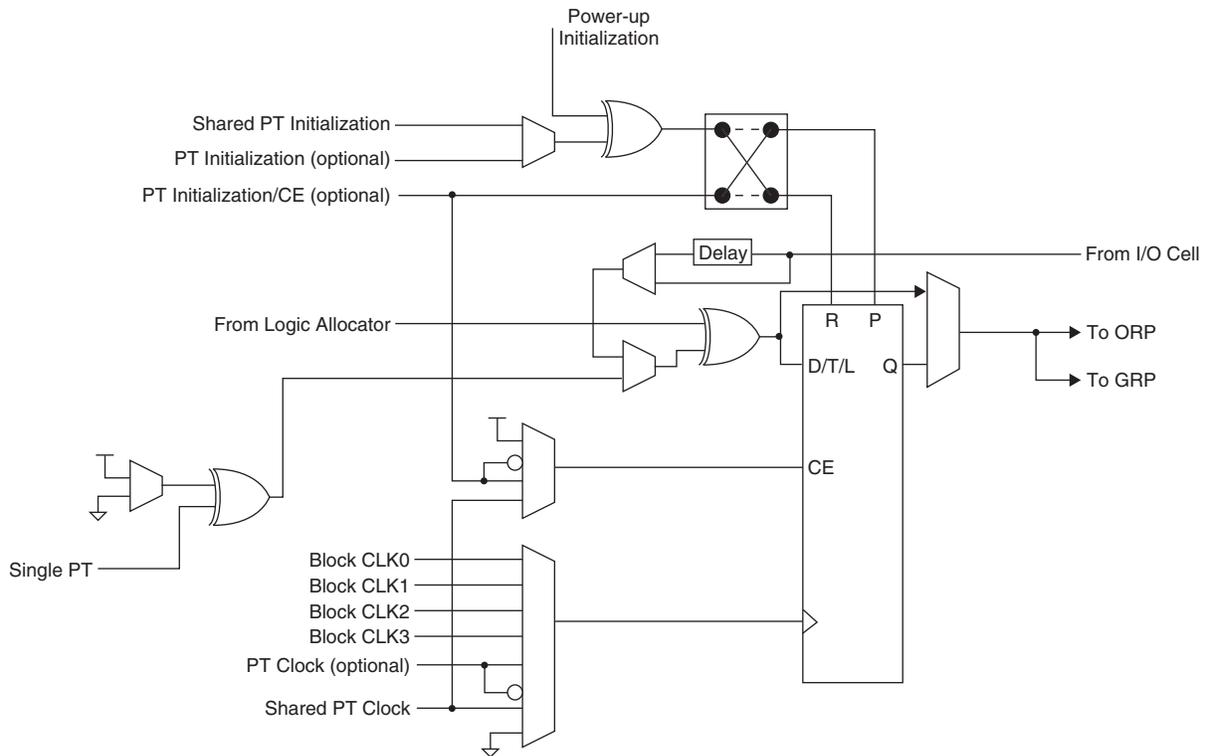
Expansion Chains	Macrocells Associated with Expansion Chain (with Wrap Around)	Max PT/Macrocell
Chain-0	M0 M4 M8 M12 M0	75
Chain-1	M1 M5 M9 M13 M1	80
Chain-2	M2 M6 M10 M14 M2	75
Chain-3	M3 M7 M11 M15 M3	70

Every time the super cluster allocator is used, there is an incremental delay of  $t_{EXP}$ . When the super cluster allocator is used, all destinations other than the one being steered to, are given the value of ground (i.e., if the super cluster is steered to M (n+4), then M (n) is ground).

**Macrocell**

The 16 macrocells in the GLB are driven by the 16 outputs from the logic allocator. Each macrocell contains a programmable XOR gate, a programmable register/latch, along with routing for the logic and control functions. Figure 5 shows a graphical representation of the macrocell. The macrocells feed the ORP and GRP. A direct input from the I/O cell allows designers to use the macrocell to construct high-speed input registers. A programmable delay in this path allows designers to choose between the fastest possible set-up time and zero hold time.

**Figure 5. Macrocell**



**Enhanced Clock Multiplexer**

The clock input to the flip-flop can select any of the four block clocks along with the shared PT clock, and true and complement forms of the optional individual term clock. An 8:1 multiplexer structure is used to select the clock. The eight sources for the clock multiplexer are as follows:

- Block CLK0
- Block CLK1

**Table 7. ORP Combinations for I/O Blocks with 16 I/Os**

I/O Cell	Available Macrocells
I/O 0	M0, M1, M2, M3, M4, M5, M6, M7
I/O 1	M1, M2, M3, M4, M5, M6, M7, M8
I/O 2	M2, M3, M4, M5, M6, M7, M8, M9
I/O 3	M3, M4, M5, M6, M7, M8, M9, M10
I/O 4	M4, M5, M6, M7, M8, M9, M10, M11
I/O 5	M5, M6, M7, M8, M9, M10, M11, M12
I/O 6	M6, M7, M8, M9, M10, M11, M12, M13
I/O 7	M7, M8, M9, M10, M11, M12, M13, M14
I/O 8	M8, M9, M10, M11, M12, M13, M14, M15
I/O 9	M9, M10, M11, M12, M13, M14, M15, M0
I/O 10	M10, M11, M12, M13, M14, M15, M0, M1
I/O 11	M11, M12, M13, M14, M15, M0, M1, M2
I/O 12	M12, M13, M14, M15, M0, M1, M2, M3
I/O 13	M13, M14, M15, M0, M1, M2, M3, M4
I/O 14	M14, M15, M0, M1, M2, M3, M4, M5
I/O 15	M15, M0, M1, M2, M3, M4, M5, M6

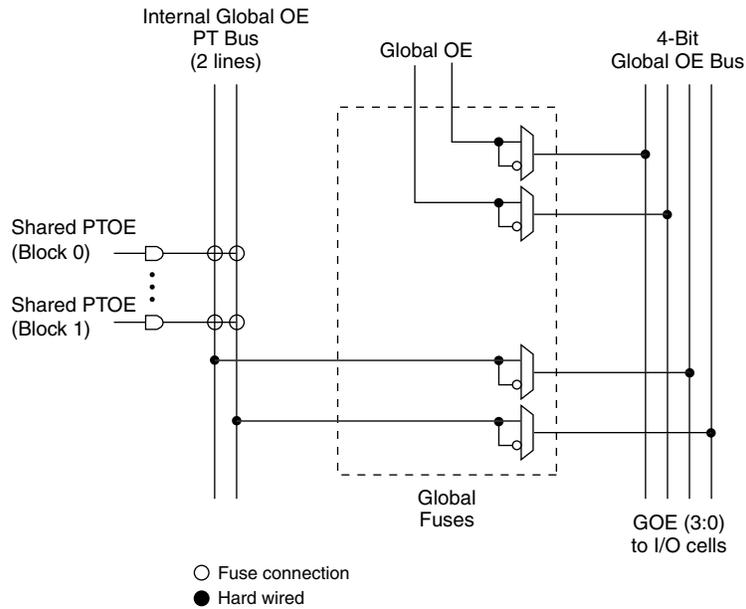
**Table 8. ORP Combinations for I/O Blocks with 4 I/Os**

I/O Cell	Available Macrocells
I/O 0	M0, M1, M2, M3, M4, M5, M6, M7
I/O 1	M4, M5, M6, M7, M8, M9, M10, M11
I/O 2	M8, M9, M10, M11, M12, M13, M14, M15
I/O 3	M12, M13, M14, M15, M0, M1, M2, M3

**Table 9. ORP Combinations for I/O Blocks with 10 I/Os**

I/O Cell	Available Macrocells
I/O 0	M0, M1, M2, M3, M4, M5, M6, M7
I/O 1	M2, M3, M4, M5, M6, M7, M8, M9
I/O 2	M4, M5, M6, M7, M8, M9, M10, M11
I/O 3	M6, M7, M8, M9, M10, M11, M12, M13
I/O 4	M8, M9, M10, M11, M12, M13, M14, M15
I/O 5	M10, M11, M12, M13, M14, M15, M0, M1
I/O 6	M12, M13, M14, M15, M0, M1, M2, M3
I/O 7	M14, M15, M0, M1, M2, M3, M4, M5
I/O 8	M2, M3, M4, M5, M6, M7, M8, M9
I/O 9	M10, M11, M12, M13, M14, M15, M0, M1

Figure 10. Global OE Generation for ispMACH 4032



## Zero Power/Low Power and Power Management

The ispMACH 4000 family is designed with high speed low power design techniques to offer both high speed and low power. With an advanced E<sup>2</sup> low power cell and non sense-amplifier design approach (full CMOS logic approach), the ispMACH 4000 family offers SuperFAST pin-to-pin speeds, while simultaneously delivering low standby power without needing any “turbo bits” or other power management schemes associated with a traditional sense-amplifier approach.

The zero power ispMACH 4000Z is based on the 1.8V ispMACH 4000C family. With innovative circuit design changes, the ispMACH 4000Z family is able to achieve the industry’s “lowest static power”.

## IEEE 1149.1-Compliant Boundary Scan Testability

All ispMACH 4000 devices have boundary scan cells and are compliant to the IEEE 1149.1 standard. This allows functional testing of the circuit board on which the device is mounted through a serial scan path that can access all critical logic nodes. Internal registers are linked internally, allowing test data to be shifted in and loaded directly onto test nodes, or test node data to be captured and shifted out for verification. In addition, these devices can be linked into a board-level serial scan path for more board-level testing. The test access port operates with an LVCMOS interface that corresponds to the power supply voltage.

## I/O Quick Configuration

To facilitate the most efficient board test, the physical nature of the I/O cells must be set before running any continuity tests. As these tests are fast, by nature, the overhead and time that is required for configuration of the I/Os’ physical nature should be minimal so that board test time is minimized. The ispMACH 4000 family of devices allows this by offering the user the ability to quickly configure the physical nature of the I/O cells. This quick configuration takes milliseconds to complete, whereas it takes seconds for the entire device to be programmed. Lattice’s ispVM<sup>®</sup> System programming software can either perform the quick configuration through the PC parallel port, or can generate the ATE or test vectors necessary for a third-party test system.

### Supply Current, ispMACH 4000V/B/C (Cont.)

Over Recommended Operating Conditions

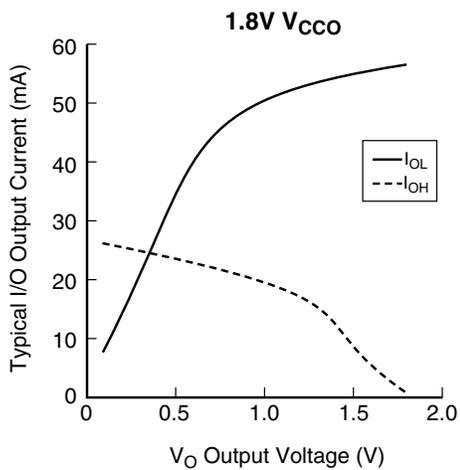
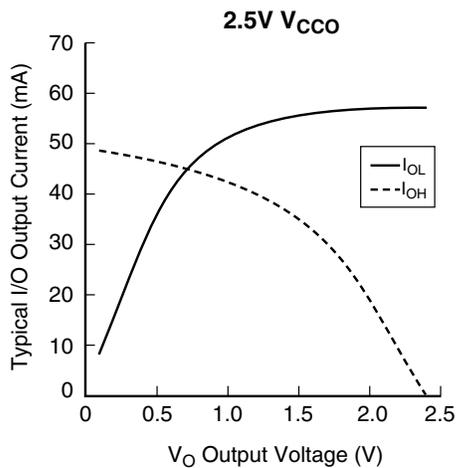
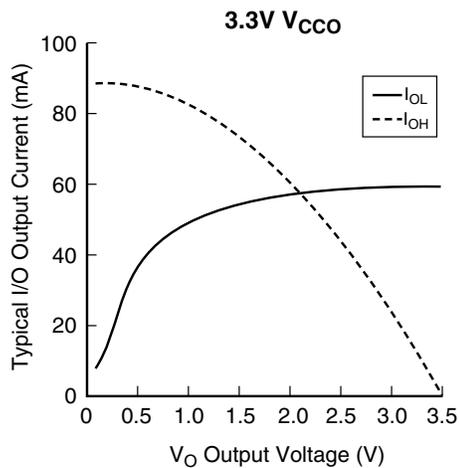
Symbol	Parameter	Condition	Min.	Typ.	Max.	Units
I <sub>CC</sub> <sup>4</sup>	Standby Power Supply Current	V <sub>CC</sub> = 3.3V	—	13	—	mA
		V <sub>CC</sub> = 2.5V	—	13	—	mA
		V <sub>CC</sub> = 1.8V	—	3	—	mA

1. T<sub>A</sub> = 25°C, frequency = 1.0 MHz.
2. Device configured with 16-bit counters.
3. I<sub>CC</sub> varies with specific device configuration and operating frequency.
4. T<sub>A</sub> = 25°C

### Supply Current, ispMACH 4000Z

Over Recommended Operating Conditions

Symbol	Parameter	Condition	Min.	Typ.	Max.	Units
<b>ispMACH 4032ZC</b>						
ICC <sup>1,2,3,5</sup>	Operating Power Supply Current	V <sub>CC</sub> = 1.8V, T <sub>A</sub> = 25°C	—	50	—	μA
		V <sub>CC</sub> = 1.9V, T <sub>A</sub> = 70°C	—	58	—	μA
		V <sub>CC</sub> = 1.9V, T <sub>A</sub> = 85°C	—	60	—	μA
		V <sub>CC</sub> = 1.9V, T <sub>A</sub> = 125°C	—	70	—	μA
ICC <sup>4,5</sup>	Standby Power Supply Current	V <sub>CC</sub> = 1.8V, T <sub>A</sub> = 25°C	—	10	—	μA
		V <sub>CC</sub> = 1.9V, T <sub>A</sub> = 70°C	—	13	20	μA
		V <sub>CC</sub> = 1.9V, T <sub>A</sub> = 85°C	—	15	25	μA
		V <sub>CC</sub> = 1.9V, T <sub>A</sub> = 125°C	—	22	—	μA
<b>ispMACH 4064ZC</b>						
ICC <sup>1,2,3,5</sup>	Operating Power Supply Current	V <sub>CC</sub> = 1.8V, T <sub>A</sub> = 25°C	—	80	—	μA
		V <sub>CC</sub> = 1.9V, T <sub>A</sub> = 70°C	—	89	—	μA
		V <sub>CC</sub> = 1.9V, T <sub>A</sub> = 85°C	—	92	—	μA
		V <sub>CC</sub> = 1.9V, T <sub>A</sub> = 125°C	—	109	—	μA
ICC <sup>4,5</sup>	Standby Power Supply Current	V <sub>CC</sub> = 1.8V, T <sub>A</sub> = 25°C	—	11	—	μA
		V <sub>CC</sub> = 1.9V, T <sub>A</sub> = 70°C	—	15	25	μA
		V <sub>CC</sub> = 1.9V, T <sub>A</sub> = 85°C	—	18	35	μA
		V <sub>CC</sub> = 1.9V, T <sub>A</sub> = 125°C	—	37	—	μA
<b>ispMACH 4128ZC</b>						
ICC <sup>1,2,3,5</sup>	Operating Power Supply Current	V <sub>CC</sub> = 1.8V, T <sub>A</sub> = 25°C	—	168	—	μA
		V <sub>CC</sub> = 1.9V, T <sub>A</sub> = 70°C	—	190	—	μA
		V <sub>CC</sub> = 1.9V, T <sub>A</sub> = 85°C	—	195	—	μA
		V <sub>CC</sub> = 1.9V, T <sub>A</sub> = 125°C	—	212	—	μA
ICC <sup>4,5</sup>	Standby Power Supply Current	V <sub>CC</sub> = 1.8V, T <sub>A</sub> = 25°C	—	12	—	μA
		V <sub>CC</sub> = 1.9V, T <sub>A</sub> = 70°C	—	16	35	μA
		V <sub>CC</sub> = 1.9V, T <sub>A</sub> = 85°C	—	19	50	μA
		V <sub>CC</sub> = 1.9V, T <sub>A</sub> = 125°C	—	42	—	μA



**ispMACH 4000V/B/C Internal Timing Parameters (Cont.)****Over Recommended Operating Conditions**

Parameter	Description	-2.5		-2.7		-3		-3.5		Units
$t_{PDLi}$	Propagation Delay through Transparent Latch to Output/ Feedback MUX	—	0.25	—	0.25	—	0.25	—	0.25	ns
$t_{SRi}$	Asynchronous Reset or Set to Output/Feedback MUX Delay	0.28	—	0.28	—	0.28	—	0.28	—	ns
$t_{SRR}$	Asynchronous Reset or Set Recovery Time	1.67	—	1.67	—	1.67	—	1.67	—	ns
<b>Control Delays</b>										
$t_{BCLK}$	GLB PT Clock Delay	—	1.12	—	1.12	—	1.12	—	1.12	ns
$t_{PTCLK}$	Macrocell PT Clock Delay	—	0.87	—	0.87	—	0.87	—	0.87	ns
$t_{BSR}$	Block PT Set/Reset Delay	—	1.83	—	1.83	—	1.83	—	1.83	ns
$t_{PTSR}$	Macrocell PT Set/Reset Delay	—	1.11	—	1.41	—	1.51	—	1.61	ns
$t_{GPtoE}$	Global PT OE Delay	—	2.83	—	4.13	—	5.33	—	5.33	ns
$t_{PtoE}$	Macrocell PT OE Delay	—	1.83	—	2.13	—	2.33	—	2.83	ns

Timing v.3.2

Note: Internal Timing Parameters are not tested and are for reference only. Refer to the Timing Model in this data sheet for further details.

## ispMACH 4000Z Internal Timing Parameters (Cont.)

Over Recommended Operating Conditions

Parameter	Description	-45		-5		-75		Units
		Min.	Max.	Min.	Max.	Min.	Max.	
<b>In/Out Delays</b>								
t <sub>IN</sub>	Input Buffer Delay	—	0.95	—	1.25	—	1.80	ns
t <sub>GOE</sub>	Global OE Pin Delay	—	3.00	—	3.50	—	4.30	ns
t <sub>GCLK_IN</sub>	Global Clock Input Buffer Delay	—	1.95	—	2.05	—	2.15	ns
t <sub>BUF</sub>	Delay through Output Buffer	—	1.10	—	1.00	—	1.30	ns
t <sub>EN</sub>	Output Enable Time	—	2.50	—	2.50	—	2.70	ns
t <sub>DIS</sub>	Output Disable Time	—	2.50	—	2.50	—	2.70	ns
<b>Routing/GLB Delays</b>								
t <sub>ROUTE</sub>	Delay through GRP	—	2.25	—	2.05	—	2.50	ns
t <sub>MCELL</sub>	Macrocell Delay	—	0.65	—	0.65	—	1.00	ns
t <sub>INREG</sub>	Input Buffer to Macrocell Register Delay	—	1.00	—	1.00	—	1.00	ns
t <sub>FBK</sub>	Internal Feedback Delay	—	0.35	—	0.05	—	0.05	ns
t <sub>PDb</sub>	5-PT Bypass Propagation Delay	—	0.20	—	0.70	—	1.90	ns
t <sub>PDi</sub>	Macrocell Propagation Delay	—	0.45	—	0.65	—	1.00	ns
<b>Register/Latch Delays</b>								
t <sub>S</sub>	D-Register Setup Time (Global Clock)	1.00	—	1.10	—	1.35	—	ns
t <sub>S_PT</sub>	D-Register Setup Time (Product Term Clock)	2.10	—	1.90	—	2.45	—	ns
t <sub>ST</sub>	T-Register Setup Time (Global Clock)	1.20	—	1.30	—	1.55	—	ns
t <sub>ST_PT</sub>	T-register Setup Time (Product Term Clock)	2.30	—	2.10	—	2.75	—	ns
t <sub>H</sub>	D-Register Hold Time	1.90	—	1.90	—	3.15	—	ns
t <sub>HT</sub>	T-Register Hold Time	1.90	—	1.90	—	3.15	—	ns
t <sub>SIR</sub>	D-Input Register Setup Time (Global Clock)	1.30	—	1.10	—	0.75	—	ns
t <sub>SIR_PT</sub>	D-Input Register Setup Time (Product Term Clock)	1.45	—	1.45	—	1.45	—	ns
t <sub>HIR</sub>	D-Input Register Hold Time (Global Clock)	1.30	—	1.50	—	1.95	—	ns
t <sub>HIR_PT</sub>	D-Input Register Hold Time (Product Term Clock)	1.00	—	1.00	—	1.18	—	ns
t <sub>COi</sub>	Register Clock to Output/Feedback MUX Time	—	0.75	—	1.15	—	1.05	ns
t <sub>CES</sub>	Clock Enable Setup Time	2.00	—	2.00	—	2.00	—	ns
t <sub>CEH</sub>	Clock Enable Hold Time	0.00	—	0.00	—	0.00	—	ns
t <sub>SL</sub>	Latch Setup Time (Global Clock)	1.00	—	1.00	—	1.65	—	ns
t <sub>SL_PT</sub>	Latch Setup Time (Product Term Clock)	2.10	—	1.90	—	2.15	—	ns
t <sub>HL</sub>	Latch Hold Time	2.00	—	2.00	—	1.17	—	ns
t <sub>GOi</sub>	Latch Gate to Output/Feedback MUX Time	—	0.33	—	0.33	—	0.33	ns
t <sub>PDLi</sub>	Propagation Delay through Transparent Latch to Output/Feedback MUX	—	0.25	—	0.25	—	0.25	ns
t <sub>SRI</sub>	Asynchronous Reset or Set to Output/Feedback MUX Delay	—	0.97	—	0.97	—	0.28	ns
t <sub>SRR</sub>	Asynchronous Reset or Set Recovery Delay	—	1.80	—	1.80	—	1.67	ns
<b>Control Delays</b>								
t <sub>BCLK</sub>	GLB PT Clock Delay	—	1.55	—	1.55	—	1.25	ns
t <sub>PTCLK</sub>	Macrocell PT Clock Delay	—	1.55	—	1.55	—	1.25	ns
t <sub>BSR</sub>	GLB PT Set/Reset Delay	—	1.83	—	1.83	—	1.83	ns
t <sub>PTSR</sub>	Macrocell PT Set/Reset Delay	—	1.83	—	1.83	—	2.72	ns
t <sub>GPTOE</sub>	Global PT OE Delay	—	4.30	—	4.20	—	3.50	ns

## ispMACH 4000Z Internal Timing Parameters (Cont.)

Over Recommended Operating Conditions

Parameter	Description	-45		-5		-75		Units
		Min.	Max.	Min.	Max.	Min.	Max.	
t <sub>P<sub>TOE</sub></sub>	Macrocell PT OE Delay	—	2.50	—	2.70	—	2.00	ns

Note: Internal Timing Parameters are not tested and are for reference only. Refer to the timing model in this data sheet for further details. Timing v.2.2

ispMACH 4000V/B/C Timing Adders<sup>1</sup>

Adder Type	Base Parameter	Description	-25		-27		-3		-35		Units
			Min.	Max.	Min.	Max.	Min.	Max.	Min.	Max.	
<b>Optional Delay Adders</b>											
t <sub>INDIO</sub>	t <sub>INREG</sub>	Input register delay	—	0.95	—	1.00	—	1.00	—	1.00	ns
t <sub>EXP</sub>	t <sub>MCELL</sub>	Product term expander delay	—	0.33	—	0.33	—	0.33	—	0.33	ns
t <sub>ORP</sub>	—	Output routing pool delay	—	0.05	—	0.05	—	0.05	—	0.05	ns
t <sub>BLA</sub>	t <sub>ROUTE</sub>	Additional block loading adder	—	0.03	—	0.05	—	0.05	—	0.05	ns
<b>t<sub>IOI</sub> Input Adjusters</b>											
LVTTTL_in	t <sub>IN</sub> , t <sub>GCLK_IN</sub> , t <sub>GOE</sub>	Using LVTTTL standard	—	0.60	—	0.60	—	0.60	—	0.60	ns
LVC MOS33_in	t <sub>IN</sub> , t <sub>GCLK_IN</sub> , t <sub>GOE</sub>	Using LVC MOS 3.3 standard	—	0.60	—	0.60	—	0.60	—	0.60	ns
LVC MOS25_in	t <sub>IN</sub> , t <sub>GCLK_IN</sub> , t <sub>GOE</sub>	Using LVC MOS 2.5 standard	—	0.60	—	0.60	—	0.60	—	0.60	ns
LVC MOS18_in	t <sub>IN</sub> , t <sub>GCLK_IN</sub> , t <sub>GOE</sub>	Using LVC MOS 1.8 standard	—	0.00	—	0.00	—	0.00	—	0.00	ns
PCI_in	t <sub>IN</sub> , t <sub>GCLK_IN</sub> , t <sub>GOE</sub>	Using PCI compatible input	—	0.60	—	0.60	—	0.60	—	0.60	ns
<b>t<sub>IOO</sub> Output Adjusters</b>											
LVTTTL_out	t <sub>BUF</sub> , t <sub>EN</sub> , t <sub>DIS</sub>	Output configured as TTL buffer	—	0.20	—	0.20	—	0.20	—	0.20	ns
LVC MOS33_out	t <sub>BUF</sub> , t <sub>EN</sub> , t <sub>DIS</sub>	Output configured as 3.3V buffer	—	0.20	—	0.20	—	0.20	—	0.20	ns
LVC MOS25_out	t <sub>BUF</sub> , t <sub>EN</sub> , t <sub>DIS</sub>	Output configured as 2.5V buffer	—	0.10	—	0.10	—	0.10	—	0.10	ns
LVC MOS18_out	t <sub>BUF</sub> , t <sub>EN</sub> , t <sub>DIS</sub>	Output configured as 1.8V buffer	—	0.00	—	0.00	—	0.00	—	0.00	ns
PCI_out	t <sub>BUF</sub> , t <sub>EN</sub> , t <sub>DIS</sub>	Output configured as PCI compatible buffer	—	0.20	—	0.20	—	0.20	—	0.20	ns
Slow Slew	t <sub>BUF</sub> , t <sub>EN</sub>	Output configured for slow slew rate	—	1.00	—	1.00	—	1.00	—	1.00	ns

Note: Open drain timing is the same as corresponding LVC MOS timing.

Timing v.3.2

1. Refer to TN1004, [ispMACH 4000 Timing Model Design and Usage Guidelines](#) for information regarding use of these adders.

ispMACH 4000V/B/C/Z Power Supply and NC Connections<sup>1</sup> (Cont.)

Signal	132-ball csBGA <sup>7</sup>	144-pin TQFP <sup>4</sup>	176-pin TQFP <sup>4</sup>	256-ball ftBGA/fpBGA <sup>2,3,7,9</sup>
VCC	P1, A14, B7, N8	36, 57, 108, 129	42, 69, 88, 130, 157, 176	B2, B15, G8, G9, K8, K9, R2, R15
VCCO0 VCCO (Bank 0)	G3, P5, C1 <sup>8</sup> , M2 <sup>8</sup> , C5	3, 19, 34, 47, 136	4, 22, 40, 56, 166	D6, F4, H7, J7, L4, N6
VCCO1 VCCO (Bank 1)	M10, M14 <sup>8</sup> , H12, A10, C13 <sup>8</sup>	64, 75, 91, 106, 119	78, 92, 110, 128, 144	D11, F13, H10, J10, L13, N11
GND	B1, P2, N14, A13	1, 37, 73, 109	2, 46 <sup>5</sup> , 65, 90, 134, 153	A1, A16, C6, C11, F3, F14, G7, G10, H8, H9, J8, J9, K7, K10, L3, L14, P6, P11, T1, T16
GND (Bank 0)	E2, K2, N4, B4	10, 18 <sup>6</sup> , 27, 46, 127, 137	13, 31, 55, 155, 167	
GND (Bank 1)	N11, K13, E13, B11	55, 65, 82, 90 <sup>6</sup> , 99, 118	67, 79, 101, 119, 143	
NC	<b>4064Z:</b> C1, C3, E1, E3, H2, J3, K1, M2, M4, N5, P7, P8, M8, P10, P11, P14, M12, K14, K12, G13, G14, E14, C13, B13, B10, C10, A7, B5, A5, A4, A1  <b>4128Z:</b> P8, A7	<b>4128V:</b> 17, 20, 38, 45, 72, 89, 92, 110, 117, 144  <b>4256V:</b> 18, 90	1, 43, 44, 45, 89, 131, 132, 133	<b>4256V/B/C, 128 I/O:</b> A4, A5, A6, A11, A12, A13, A15, B5, B6, B11, B12, B14, C7, D1, D4, D5, D10, D12, D16, E1, E2, E4, E5, E7, E10, E13, E14, E15, E16, F1, F2, F15, F16, G1, G4, G5, G6, G12, G13, G14, J11, K3, K4, K15, L1, L2, L12, L15, L16, M1, M2, M3, M4, M5, M12, M13, M15, M16, N1, N2, N7, N10, N12, N14, P5, P12, R4, R5, R6, R11, R12, R16, T2, T4, T5, T6, T11, T12, T13, T15  <b>4256V/B/C, 160 I/O:</b> A5, A12, A15, B5, B6, B11, B12, B14, D4, D5, D12, E1, E4, E5, E13, E15, E16, F1, F2, F15, G1, G5, G12, G14, L1, L2, L12, L15, L16, M1, M2, M3, M12, M16, N1, N12, N14, P5, R4, R5, R6, R11, R12, R16, T4, T5, T12, T15  <b>4384V/B/C:</b> B5, B12, D5, D12, E1, E15, E16, F2, L12, M1, M2, M16, N12, R5, R12, T4  <b>4512V/B/C:</b> None

1. All grounds must be electrically connected at the board level. However, for the purposes of I/O current loading, grounds are associated with the bank shown.
2. Internal GNDs and I/O GNDs (Bank 0/1) are connected inside package.
3. V<sub>CCO</sub> balls connect to two power planes within the package, one for V<sub>CCO0</sub> and one for V<sub>CCO1</sub>.
4. Pin orientation follows the conventional order from pin 1 marking of the top side view and counter-clockwise.
5. ispMACH 4384V/B/C pin 46 is tied to GND (Bank 0).
6. ispMACH 4128V only.
7. Pin orientation A1 starts from the upper left corner of the top side view with alphabetical order ascending vertically and numerical order ascending horizontally.
8. ispMACH 4128Z and 4256Z only. NC for ispMACH 4064Z.
9. Use 256 ftBGA package for all new designs. Refer to PCN#14A-07 for 256 fpBGA package discontinuance.

**ispMACH 4128V/B/C Logic Signal Connections: 128-Pin TQFP (Cont.)**

Pin Number	Bank Number	ispMACH 4128V/B/C	
		GLB/MC/Pad	ORP
105	1	VCCO (Bank 1)	-
106	1	H6	H <sup>5</sup>
107	1	H5	H <sup>4</sup>
108	1	H4	H <sup>3</sup>
109	1	H2	H <sup>2</sup>
110	1	H1	H <sup>1</sup>
111	1	H0/GOE1	H <sup>0</sup>
112	1	CLK3/I	-
113	0	GND (Bank 0)	-
114	0	CLK0/I	-
115	0	VCC	-
116	0	A0/GOE0	A <sup>0</sup>
117	0	A1	A <sup>1</sup>
118	0	A2	A <sup>2</sup>
119	0	A4	A <sup>3</sup>
120	0	A5	A <sup>4</sup>
121	0	A6	A <sup>5</sup>
122	0	VCCO (Bank 0)	-
123	0	GND (Bank 0)	-
124	0	A8	A <sup>6</sup>
125	0	A9	A <sup>7</sup>
126	0	A10	A <sup>8</sup>
127	0	A12	A <sup>9</sup>
128	0	A14	A <sup>11</sup>

**ispMACH 4064Z, 4128Z and 4256Z Logic Signal Connections:  
132-Ball csBGA**

Ball Number	Bank Number	ispMACH 4064Z		ispMACH 4128Z		ispMACH 4256Z	
		GLB/MC/Pad	ORP	GLB/MC/Pad	ORP	GLB/MC/Pad	ORP
B1	-	GND	-	GND	-	GND	-
B2	-	TDI	-	TDI	-	TDI	-
C1	0	NC	-	VCCO (Bank 0)	-	VCCO (Bank 0)	-
C3	0	NC	-	B0	B <sup>0</sup>	C12	C <sup>6</sup>
C2	0	A8	A <sup>8</sup>	B1	B <sup>1</sup>	C10	C <sup>5</sup>
D1	0	A9	A <sup>9</sup>	B2	B <sup>2</sup>	C8	C <sup>4</sup>
D3	0	A10	A <sup>10</sup>	B4	B <sup>3</sup>	C6	C <sup>3</sup>
D2	0	A11	A <sup>11</sup>	B5	B <sup>4</sup>	C4	C <sup>2</sup>
E1	0	NC	-	B6	B <sup>5</sup>	C2	C <sup>1</sup>
E2	0	GND (Bank 0)	-	GND (Bank 0)	-	GND (Bank 0)	-

### ispMACH 4064Z, 4128Z and 4256Z Logic Signal Connections: 132-Ball csBGA (Cont.)

Ball Number	Bank Number	ispMACH 4064Z		ispMACH 4128Z		ispMACH 4256Z	
		GLB/MC/Pad	ORP	GLB/MC/Pad	ORP	GLB/MC/Pad	ORP
D13	1	D10	D <sup>10</sup>	G4	G <sup>3</sup>	N6	N <sup>3</sup>
D14	1	D9	D <sup>9</sup>	G2	G <sup>2</sup>	N8	N <sup>4</sup>
D12	1	D8	D <sup>8</sup>	G1	G <sup>1</sup>	N10	N <sup>5</sup>
C14	1	I	-	G0	G <sup>0</sup>	N12	N <sup>6</sup>
C13	1	NC	-	VCCO (Bank 1)	-	VCCO (Bank 1)	-
B14	-	TDO	-	TDO	-	TDO	-
A14	-	VCC	-	VCC	-	VCC	-
A13	-	GND	-	GND	-	GND	-
B13	1	NC	-	H14	H <sup>11</sup>	O12	O <sup>6</sup>
A12	1	I	-	H13	H <sup>10</sup>	O10	O <sup>5</sup>
C12	1	D7	D <sup>7</sup>	H12	H <sup>9</sup>	O8	O <sup>4</sup>
B12	1	D6	D <sup>6</sup>	H10	H <sup>8</sup>	O6	O <sup>3</sup>
A11	1	D5	D <sup>5</sup>	H9	H <sup>7</sup>	O4	O <sup>2</sup>
C11	1	D4	D <sup>4</sup>	H8	H <sup>6</sup>	O2	O <sup>1</sup>
B11	1	GND (Bank 1)	-	GND (Bank 1)	-	GND (Bank 1)	-
A10	1	VCCO (Bank 1)	-	VCCO (Bank 1)	-	VCCO (Bank 1)	-
B10	1	NC	-	H6	H <sup>5</sup>	P12	P <sup>6</sup>
C10	1	NC	-	H5	H <sup>4</sup>	P10	P <sup>5</sup>
B9	1	D3	D <sup>3</sup>	H4	H <sup>3</sup>	P8	P <sup>4</sup>
A9	1	D2	D <sup>2</sup>	H2	H <sup>2</sup>	P6	P <sup>3</sup>
C9	1	D1	D <sup>1</sup>	H1	H <sup>1</sup>	P4	P <sup>2</sup>
A8	1	D0/GOE1	D <sup>0</sup>	H0/GOE1	H <sup>0</sup>	P2/GOE1	P <sup>1</sup>
B8	1	CLK3/I	-	CLK3/I	-	CLK3/I	-
C8	0	CLK0/I	-	CLK0/I	-	CLK0/I	-
B7	-	VCC	-	VCC	-	VCC	-
A7	0	NC <sup>1</sup>	-	NC <sup>1</sup>	-	I <sup>1</sup>	-
C7	0	A0/GOE0	A <sup>0</sup>	A0/GOE0	A <sup>0</sup>	A2/GOE0	A <sup>1</sup>
A6	0	A1	A <sup>1</sup>	A1	A <sup>1</sup>	A4	A <sup>2</sup>
B6	0	A2	A <sup>2</sup>	A2	A <sup>2</sup>	A6	A <sup>3</sup>
C6	0	A3	A <sup>3</sup>	A4	A <sup>3</sup>	A8	A <sup>4</sup>
B5	0	NC	-	A5	A <sup>4</sup>	A10	A <sup>5</sup>
A5	0	NC	-	A6	A <sup>5</sup>	A12	A <sup>6</sup>
C5	0	VCCO (Bank 0)	-	VCCO (Bank 0)	-	VCCO (Bank 0)	-
B4	0	GND (Bank 0)	-	GND (Bank 0)	-	GND (Bank 0)	-
A4	0	NC	-	A8	A <sup>6</sup>	B2	B <sup>1</sup>
C4	0	A4	A <sup>4</sup>	A9	A <sup>7</sup>	B4	B <sup>2</sup>
A3	0	A5	A <sup>5</sup>	A10	A <sup>8</sup>	B6	B <sup>3</sup>
B3	0	A6	A <sup>6</sup>	A12	A <sup>9</sup>	B8	B <sup>4</sup>
A2	0	A7	A <sup>7</sup>	A13	A <sup>10</sup>	B10	B <sup>5</sup>
A1	0	NC	-	A14	A <sup>11</sup>	B12	B <sup>6</sup>

1. For device migration considerations, these NC pins are input signal pins in ispMACH 4256Z device.

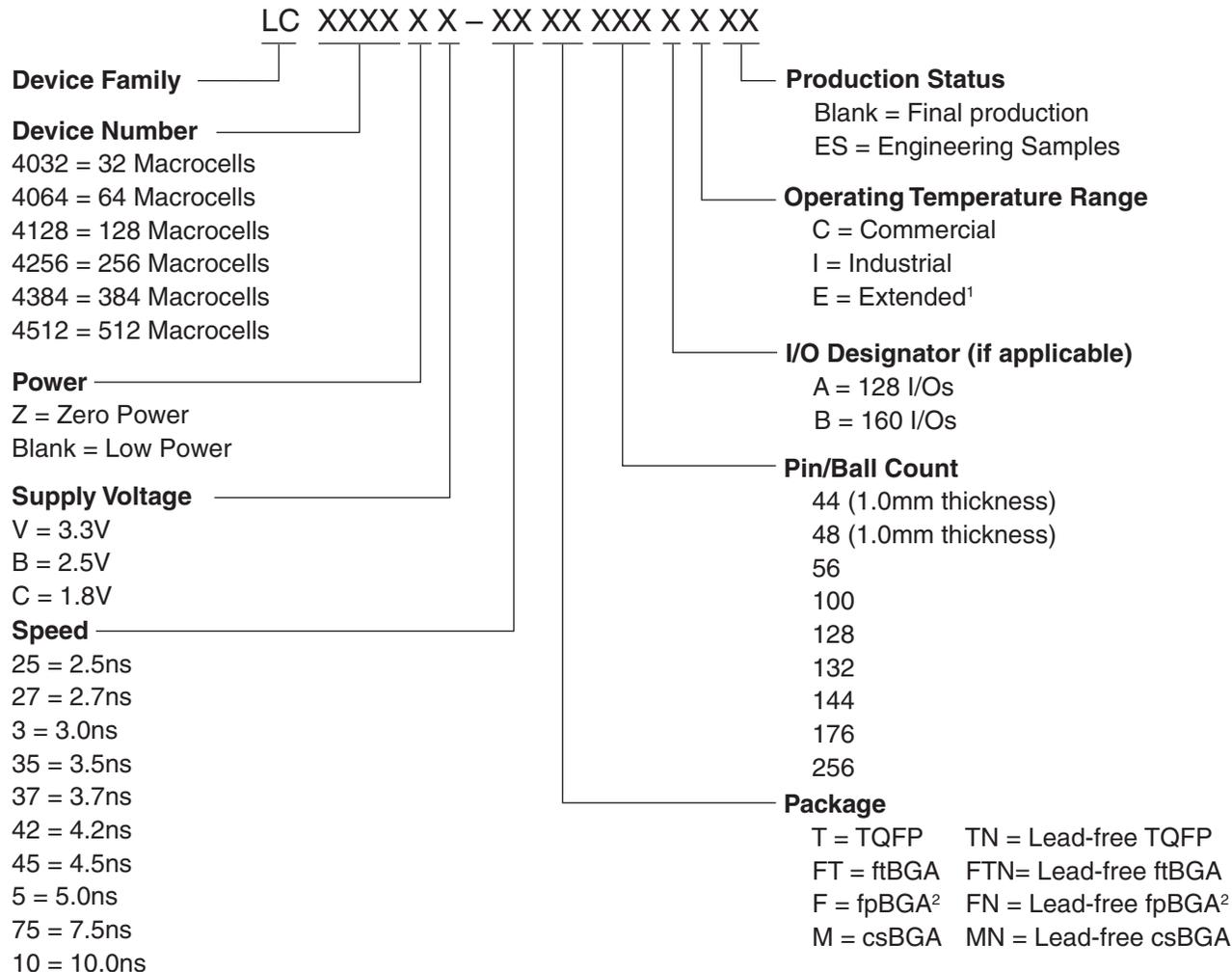
**ispMACH 4256V/B/C/Z, 4384V/B/C, 4512V/B/C, Logic Signal Connections:  
176-Pin TQFP (Cont.)**

Pin Number	Bank Number	ispMACH 4256V/B/C/Z		ispMACH 4384V/B/C		ispMACH 4512V/B/C	
		GLB/MC/Pad	ORP	GLB/MC/Pad	ORP	GLB/MC/Pad	ORP
19	0	D4	D <sup>2</sup>	E4	E <sup>2</sup>	G4	G <sup>2</sup>
20	0	D2	D <sup>1</sup>	E2	E <sup>1</sup>	G2	G <sup>1</sup>
21	0	D0	D <sup>0</sup>	E0	E <sup>0</sup>	G0	G <sup>0</sup>
22	0	VCCO (Bank 0)	-	VCCO (Bank 0)	-	VCCO (Bank 0)	-
23	0	E0	E <sup>0</sup>	H0	H <sup>0</sup>	J0	J <sup>0</sup>
24	0	E2	E <sup>1</sup>	H2	H <sup>1</sup>	J2	J <sup>1</sup>
25	0	E4	E <sup>2</sup>	H4	H <sup>2</sup>	J4	J <sup>2</sup>
26	0	E6	E <sup>3</sup>	H6	H <sup>3</sup>	J6	J <sup>3</sup>
27	0	E8	E <sup>4</sup>	H8	H <sup>4</sup>	J8	J <sup>4</sup>
28	0	E10	E <sup>5</sup>	H10	H <sup>5</sup>	J10	J <sup>5</sup>
29	0	E12	E <sup>6</sup>	H12	H <sup>6</sup>	J12	J <sup>6</sup>
30	0	E14	E <sup>7</sup>	H14	H <sup>7</sup>	J14	J <sup>7</sup>
31	0	GND (Bank 0)	-	GND (Bank 0)	-	GND (Bank 0)	-
32	0	F0	F <sup>0</sup>	J0	J <sup>0</sup>	N0	N <sup>0</sup>
33	0	F2	F <sup>1</sup>	J2	J <sup>1</sup>	N2	N <sup>1</sup>
34	0	F4	F <sup>2</sup>	J4	J <sup>2</sup>	N4	N <sup>2</sup>
35	0	F6	F <sup>3</sup>	J6	J <sup>3</sup>	N6	N <sup>3</sup>
36	0	F8	F <sup>4</sup>	J8	J <sup>4</sup>	N8	N <sup>4</sup>
37	0	F10	F <sup>5</sup>	J10	J <sup>5</sup>	N10	N <sup>5</sup>
38	0	F12	F <sup>6</sup>	J12	J <sup>6</sup>	N12	N <sup>6</sup>
39	0	F14	F <sup>7</sup>	J14	J <sup>7</sup>	N14	N <sup>7</sup>
40	0	VCCO (Bank 0)	-	VCCO (Bank 0)	-	VCCO (Bank 0)	-
41	-	TCK	-	TCK	-	TCK	-
42	-	VCC	-	VCC	-	VCC	-
43	-	NC	-	NC	-	NC	-
44	-	NC	-	NC	-	NC	-
45	-	NC	-	NC	-	NC	-
46	-	GND	-	GND (Bank 0)	-	GND	-
47	0	G14	G <sup>7</sup>	K14	K <sup>7</sup>	O14	O <sup>7</sup>
48	0	G12	G <sup>6</sup>	K12	K <sup>6</sup>	O12	O <sup>6</sup>
49	0	G10	G <sup>5</sup>	K10	K <sup>5</sup>	O10	O <sup>5</sup>
50	0	G8	G <sup>4</sup>	K8	K <sup>4</sup>	O8	O <sup>4</sup>
51	0	G6	G <sup>3</sup>	K6	K <sup>3</sup>	O6	O <sup>3</sup>
52	0	G4	G <sup>2</sup>	K4	K <sup>2</sup>	O4	O <sup>2</sup>
53	0	G2	G <sup>1</sup>	K2	K <sup>1</sup>	O2	O <sup>1</sup>
54	0	G0	G <sup>0</sup>	K0	K <sup>0</sup>	O0	O <sup>0</sup>
55	0	GND (Bank 0)	-	GND (Bank 0)	-	GND (Bank 0)	-
56	0	VCCO (Bank 0)	-	VCCO (Bank 0)	-	VCCO (Bank 0)	-
57	0	H14	H <sup>7</sup>	L14	L <sup>7</sup>	P14	P <sup>7</sup>
58	0	H12	H <sup>6</sup>	L12	L <sup>6</sup>	P12	P <sup>6</sup>
59	0	H10	H <sup>5</sup>	L10	L <sup>5</sup>	P10	P <sup>5</sup>

**ispMACH 4256V/B/C/Z, 4384V/B/C, 4512V/B/C, Logic Signal Connections:  
176-Pin TQFP (Cont.)**

Pin Number	Bank Number	ispMACH 4256V/B/C/Z		ispMACH 4384V/B/C		ispMACH 4512V/B/C	
		GLB/MC/Pad	ORP	GLB/MC/Pad	ORP	GLB/MC/Pad	ORP
142	1	O0	O^0	GX0	GX^0	OX0	OX^0
143	1	GND (Bank 1)	-	GND (Bank 1)	-	GND (Bank 1)	-
144	1	VCCO (Bank 1)	-	VCCO (Bank 1)	-	VCCO (Bank 1)	-
145	1	P14	P^7	HX14	HX^7	PX14	PX^7
146	1	P12	P^6	HX12	HX^6	PX12	PX^6
147	1	P10	P^5	HX10	HX^5	PX10	PX^5
148	1	P8	P^4	HX8	HX^4	PX8	PX^4
149	1	P6	P^3	HX6	HX^3	PX6	PX^3
150	1	P4	P^2	HX4	HX^2	PX4	PX^2
151	1	P2/GOE1	P^1	HX2/GOE1	HX^1	PX2/GOE1	PX^1
152	1	P0	P^0	HX0	HX^0	PX0	PX^0
153	-	GND	-	GND	-	GND	-
154	1	CLK3/I	-	CLK3/I	-	CLK3/I	-
155	0	GND (Bank 0)	-	GND (Bank 0)	-	GND (Bank 0)	-
156	0	CLK0/I	-	CLK0/I	-	CLK0/I	-
157	-	VCC	-	VCC	-	VCC	-
158	0	A0	A^0	A0	A^0	A0	A^0
159	0	A2/GOE0	A^1	A2/GOE0	A^1	A2/GOE0	A^1
160	0	A4	A^2	A4	A^2	A4	A^2
161	0	A6	A^3	A6	A^3	A6	A^3
162	0	A8	A^4	A8	A^4	A8	A^4
163	0	A10	A^5	A10	A^5	A10	A^5
164	0	A12	A^6	A12	A^6	A12	A^6
165	0	A14	A^7	A14	A^7	A14	A^7
166	0	VCCO (Bank 0)	-	VCCO (Bank 0)	-	VCCO (Bank 0)	-
167	0	GND (Bank 0)	-	GND (Bank 0)	-	GND (Bank 0)	-
168	0	B0	B^0	B0	B^0	B0	B^0
169	0	B2	B^1	B2	B^1	B2	B^1
170	0	B4	B^2	B4	B^2	B4	B^2
171	0	B6	B^3	B6	B^3	B6	B^3
172	0	B8	B^4	B8	B^4	B8	B^4
173	0	B10	B^5	B10	B^5	B10	B^5
174	0	B12	B^6	B12	B^6	B12	B^6
175	0	B14	B^7	B14	B^7	B14	B^7
176	-	VCC	-	VCC	-	VCC	-

**Part Number Description**



1. For automotive AEC-Q100 compliant devices, refer to the LA-ispMACH 4000V/Z Automotive Family Data Sheet (DS1017).  
 2. Use ftBGA package. fpBGA package devices have been discontinued via PCN#14A-07.

**ispMACH 4000 Family Speed Grade Offering**

	-25	-27	-3	-35	-37	-42	-45	-5		-75			-10
	Com	Ind	Com	Ind	Ext	Ind							
ispMACH 4032V/B/C												1	
ispMACH 4064V/B/C												1	
ispMACH 4128V/B/C												1	
ispMACH 4256V/B/C													
ispMACH 4384V/B/C													
ispMACH 4512V/B/C													
ispMACH 4032ZC												1	
ispMACH 4064ZC												1	
ispMACH 4128ZC												1	
ispMACH 4256ZC													

1. 3.3V only.

## Ordering Information

Note: ispMACH 4000 devices are all dual marked except the slowest commercial speed grade ispMACH 4000Z devices. For example, the commercial speed grade LC4128C-5T100C is also marked with the industrial grade -75I. The commercial grade is always one speed grade faster than the associated dual mark industrial grade. The slowest commercial speed grade ispMACH 4000Z devices are marked as commercial grade only.

## Conventional Packaging

### ispMACH 4000ZC (Zero Power, 1.8V) Commercial Devices

Device	Part Number	Macrocells	Voltage	t <sub>PD</sub>	Package	Pin/Ball Count	I/O	Grade
LC4032ZC	LC4032ZC-35M56C	32	1.8	3.5	csBGA	56	32	C
	LC4032ZC-5M56C	32	1.8	5	csBGA	56	32	C
	LC4032ZC-75M56C	32	1.8	7.5	csBGA	56	32	C
	LC4032ZC-35T48C	32	1.8	3.5	TQFP	48	32	C
	LC4032ZC-5T48C	32	1.8	5	TQFP	48	32	C
	LC4032ZC-75T48C	32	1.8	7.5	TQFP	48	32	C
LC4064ZC	LC4064ZC-37M132C	64	1.8	3.7	csBGA	132	64	C
	LC4064ZC-5M132C	64	1.8	5	csBGA	132	64	C
	LC4064ZC-75M132C	64	1.8	7.5	csBGA	132	64	C
	LC4064ZC-37T100C	64	1.8	3.7	TQFP	100	64	C
	LC4064ZC-5T100C	64	1.8	5	TQFP	100	64	C
	LC4064ZC-75T100C	64	1.8	7.5	TQFP	100	64	C
	LC4064ZC-37M56C	64	1.8	3.7	csBGA	56	32	C
	LC4064ZC-5M56C	64	1.8	5	csBGA	56	32	C
	LC4064ZC-75M56C	64	1.8	7.5	csBGA	56	32	C
	LC4064ZC-37T48C	64	1.8	3.7	TQFP	48	32	C
	LC4064ZC-5T48C	64	1.8	5	TQFP	48	32	C
	LC4064ZC-75T48C	64	1.8	7.5	TQFP	48	32	C
LC4128ZC	LC4128ZC-42M132C	128	1.8	4.2	csBGA	132	96	C
	LC4128ZC-75M132C	128	1.8	7.5	csBGA	132	96	C
	LC4128ZC-42T100C	128	1.8	4.2	TQFP	100	64	C
	LC4128ZC-75T100C	128	1.8	7.5	TQFP	100	64	C
LC4256ZC	LC4256ZC-45T176C	256	1.8	4.5	TQFP	176	128	C
	LC4256ZC-75T176C	256	1.8	7.5	TQFP	176	128	C
	LC4256ZC-45M132C	256	1.8	4.5	csBGA	132	96	C
	LC4256ZC-75M132C	256	1.8	7.5	csBGA	132	96	C
	LC4256ZC-45T100C	256	1.8	4.5	TQFP	100	64	C
	LC4256ZC-75T100C	256	1.8	7.5	TQFP	100	64	C

### ispMACH 4000ZC (1.8V, Zero Power) Industrial Devices

Device	Part Number	Macrocells	Voltage	t <sub>PD</sub>	Package	Pin/Ball Count	I/O	Grade
LC4032ZC	LC4032ZC-5M56I	32	1.8	5	csBGA	56	32	I
	LC4032ZC-75M56I	32	1.8	7.5	csBGA	56	32	I
	LC4032ZC-5T48I	32	1.8	5	TQFP	48	32	I
	LC4032ZC-75T48I	32	1.8	7.5	TQFP	48	32	I

## ispMACH 4000C (1.8V) Commercial Devices (Cont.)

Device	Part Number	Macrocells	Voltage	t <sub>PD</sub>	Package	Pin/Ball Count	I/O	Grade
LC4128C	LC4128C-27T128C	128	1.8	2.7	TQFP	128	92	C
	LC4128C-5T128C	128	1.8	5	TQFP	128	92	C
	LC4128C-75T128C	128	1.8	7.5	TQFP	128	92	C
	LC4128C-27T100C	128	1.8	2.7	TQFP	100	64	C
	LC4128C-5T100C	128	1.8	5	TQFP	100	64	C
	LC4128C-75T100C	128	1.8	7.5	TQFP	100	64	C
LC4256C	LC4256C-3FT256AC	256	1.8	3	ftBGA	256	128	C
	LC4256C-5FT256AC	256	1.8	5	ftBGA	256	128	C
	LC4256C-75FT256AC	256	1.8	7.5	ftBGA	256	128	C
	LC4256C-3FT256BC	256	1.8	3	ftBGA	256	160	C
	LC4256C-5FT256BC	256	1.8	5	ftBGA	256	160	C
	LC4256C-75FT256BC	256	1.8	7.5	ftBGA	256	160	C
	LC4256C-3F256AC <sup>1</sup>	256	1.8	3	fpBGA	256	128	C
	LC4256C-5F256AC <sup>1</sup>	256	1.8	5	fpBGA	256	128	C
	LC4256C-75F256AC <sup>1</sup>	256	1.8	7.5	fpBGA	256	128	C
	LC4256C-3F256BC <sup>1</sup>	256	1.8	3	fpBGA	256	160	C
	LC4256C-5F256BC <sup>1</sup>	256	1.8	5	fpBGA	256	160	C
	LC4256C-75F256BC <sup>1</sup>	256	1.8	7.5	fpBGA	256	160	C
	LC4256C-3T176C	256	1.8	3	TQFP	176	128	C
	LC4256C-5T176C	256	1.8	5	TQFP	176	128	C
	LC4256C-75T176C	256	1.8	7.5	TQFP	176	128	C
	LC4256C-3T100C	256	1.8	3	TQFP	100	64	C
LC4256C-5T100C	256	1.8	5	TQFP	100	64	C	
LC4256C-75T100C	256	1.8	7.5	TQFP	100	64	C	
LC4384C	LC4384C-35FT256C	384	1.8	3.5	ftBGA	256	192	C
	LC4384C-5FT256C	384	1.8	5	ftBGA	256	192	C
	LC4384C-75FT256C	384	1.8	7.5	ftBGA	256	192	C
	LC4384C-35F256C <sup>1</sup>	384	1.8	3.5	fpBGA	256	192	C
	LC4384C-5F256C <sup>1</sup>	384	1.8	5	fpBGA	256	192	C
	LC4384C-75F256C <sup>1</sup>	384	1.8	7.5	fpBGA	256	192	C
	LC4384C-35T176C	384	1.8	3.5	TQFP	176	128	C
	LC4384C-5T176C	384	1.8	5	TQFP	176	128	C
	LC4384C-75T176C	384	1.8	7.5	TQFP	176	128	C
LC4512C	LC4512C-35FT256C	512	1.8	3.5	ftBGA	256	208	C
	LC4512C-5FT256C	512	1.8	5	ftBGA	256	208	C
	LC4512C-75FT256C	512	1.8	7.5	ftBGA	256	208	C
	LC4512C-35F256C <sup>1</sup>	512	1.8	3.5	fpBGA	256	208	C
	LC4512C-5F256C <sup>1</sup>	512	1.8	5	fpBGA	256	208	C
	LC4512C-75F256C <sup>1</sup>	512	1.8	7.5	fpBGA	256	208	C
	LC4512C-35T176C	512	1.8	3.5	TQFP	176	128	C
	LC4512C-5T176C	512	1.8	5	TQFP	176	128	C
LC4512C-75T176C	512	1.8	7.5	TQFP	176	128	C	

1. Use ftBGA package. fpBGA package devices have been discontinued via PCN#14A-07.

## ispMACH 4000V (3.3V) Lead-Free Commercial Devices

Device	Part Number	Macrocells	Voltage	t <sub>PD</sub>	Package	Pin/Ball Count	I/O	Grade
LC4032V	LC4032V-25TN48C	32	3.3	2.5	Lead-free TQFP	48	32	C
	LC4032V-5TN48C	32	3.3	5	Lead-free TQFP	48	32	C
	LC4032V-75TN48C	32	3.3	7.5	Lead-free TQFP	48	32	C
	LC4032V-25TN44C	32	3.3	2.5	Lead-free TQFP	44	30	C
	LC4032V-5TN44C	32	3.3	5	Lead-free TQFP	44	30	C
	LC4032V-75TN44C	32	3.3	7.5	Lead-free TQFP	44	30	C
LC4064V	LC4064V-25TN100C	64	3.3	2.5	Lead-free TQFP	100	64	C
	LC4064V-5TN100C	64	3.3	5	Lead-free TQFP	100	64	C
	LC4064V-75TN100C	64	3.3	7.5	Lead-free TQFP	100	64	C
	LC4064V-25TN48C	64	3.3	2.5	Lead-free TQFP	48	32	C
	LC4064V-5TN48C	64	3.3	5	Lead-free TQFP	48	32	C
	LC4064V-75TN48C	64	3.3	7.5	Lead-free TQFP	48	32	C
	LC4064V-25TN44C	64	3.3	2.5	Lead-free TQFP	44	30	C
	LC4064V-5TN44C	64	3.3	5	Lead-free TQFP	44	30	C
	LC4064V-75TN44C	64	3.3	7.5	Lead-free TQFP	44	30	C
LC4128V	LC4128V-27TN144C	128	3.3	2.7	Lead-free TQFP	144	96	C
	LC4128V-5TN144C	128	3.3	5	Lead-free TQFP	144	96	C
	LC4128V-75TN144C	128	3.3	7.5	Lead-free TQFP	144	96	C
	LC4128V-27TN128C	128	3.3	2.7	Lead-free TQFP	128	92	C
	LC4128V-5TN128C	128	3.3	5	Lead-free TQFP	128	92	C
	LC4128V-75TN128C	128	3.3	7.5	Lead-free TQFP	128	92	C
	LC4128V-27TN100C	128	3.3	2.7	Lead-free TQFP	100	64	C
	LC4128V-5TN100C	128	3.3	5	Lead-free TQFP	100	64	C
	LC4128V-75TN100C	128	3.3	7.5	Lead-free TQFP	100	64	C

**Revision History (Cont.)**

Date	Version	Change Summary
January 2004	20z	ispMACH 4000Z data sheet status changed from preliminary to final. Documents production release of the ispMACH 4256Z device.
		Added new feature - ispMACH 4000Z supports operation down to 1.6V.
		Added lead-free packaging ordering part numbers for the ispMACH 4000Z/C/V devices.
April 2004	21z	Updated $I_{PU}$ (I/O Weak Pull-up Resistor Current) max. specification for the ispMACH 4000V/B/C; -150 $\mu$ A to -200 $\mu$ A.
November 2004	22z	Added User Electronic Signature section.
		Added ispMACH 4000B (2.5V) Lead-Free Ordering Part Numbers.
December 2004	22z.1	Updated Further Information section.
February 2006	22z.2	Clarification to ispMACH 4000Z Input Leakage ( $I_{IH}$ ) specification.
March 2007	22.3	Updated ispMACH 4000 Introduction section.
		Updated Signal Descriptions table.
June 2007	22.4	Updated Features bullets to include reference to "LA" automotive data sheet under the "Broad Device Offering" bullet.
		Added footnote 1 to Part Number Description to reference the "LA" automotive data sheet.
		Changed device temperature references from 'Automotive' to "Extended Temperature" for non-AEC-Q100 qualified devices.
November 2007	23.0	Added 256-ftBGA package Ordering Part Number information per PCN#14A-07.
May 2009	23.1	Correction to $t_{CW}$ , $t_{GW}$ , $t_{WIR}$ and $f_{MAX}$ parameters in ispMACH 4000Z External Switching Characteristics table.
		Correction to $t_{CW}$ , $t_{GW}$ , $t_{WIR}$ and $f_{MAX}$ parameters in ispMACH 4000V/B/C External Switching Characteristics table.